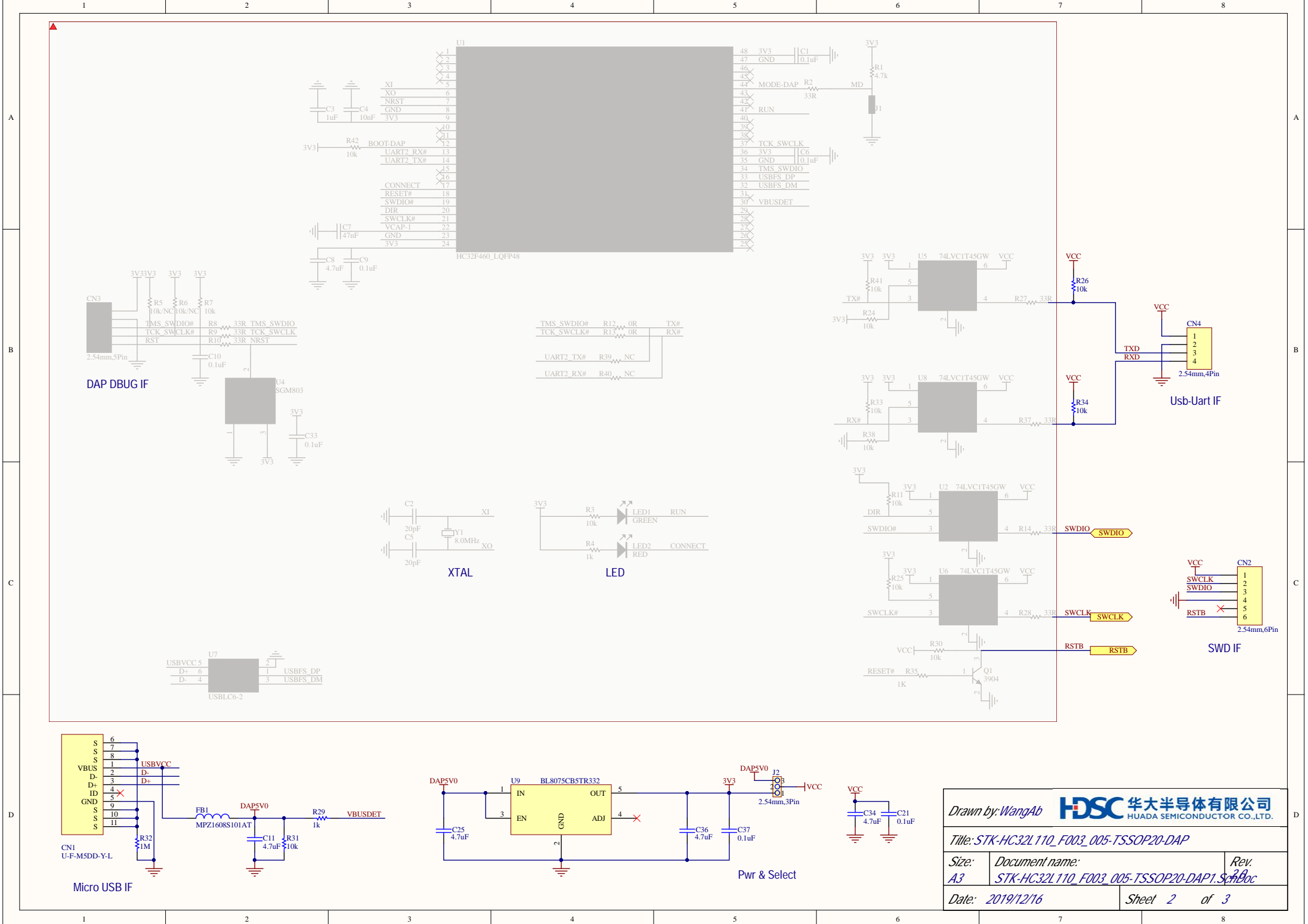
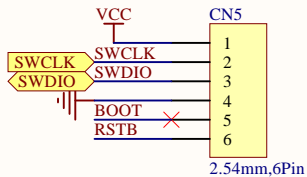
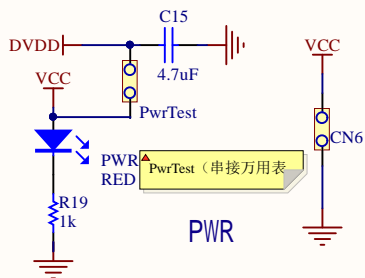
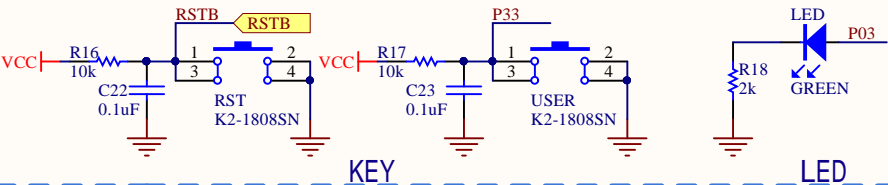
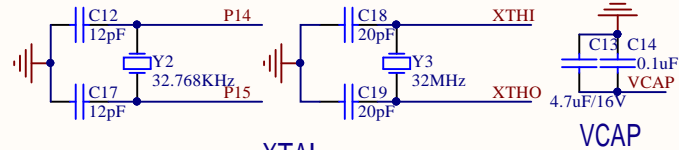


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| Date: 2019/12/16 | | Sheet 1 of 3 |

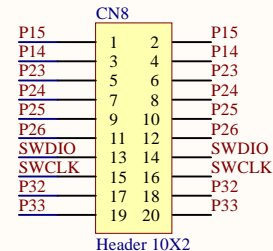
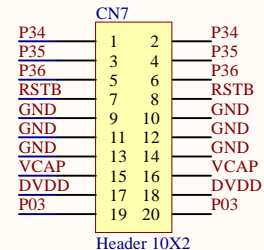




▲ L系列有外部低速晶体;
F系列无外部低速晶体;

| | | | | | |
|------|----|------------------|--------------|----|-------|
| P34 | 1 | P34/AN4/VC4 | VC3/AN3/P33 | 20 | P33 |
| P35 | 2 | P35/AN5/VC5 | VC2/AN2/P32 | 19 | P32 |
| P36 | 3 | P36/AN6/VC6/Vref | SWCLK/P31 | 18 | SWCLK |
| RSTB | 4 | P00/RST | SWDIO/P27 | 17 | SWDIO |
| XTHI | 5 | P01/XHI/AN7/VC7 | AN1/P26 | 16 | P26 |
| XTHO | 6 | P02/XHO/AN8 | LVD3/VC1/P25 | 15 | P25 |
| GND | 7 | GND | AN0/P24 | 14 | P24 |
| VCAP | 8 | VCAP | LVD2/VC0/P23 | 13 | P23 |
| DVDD | 9 | VDD | P14 | 12 | P14 |
| P03 | 10 | P03/LVD1 | P15 | 11 | P15 |

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EXT_I0 I/F

Drawn by: Wangat

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Date: 2019/12/16 Sheet 3 of 3

